

MN65543S

Low Power 8-Bit CMOS A/D Converter for Image Processing

Overview

The MN65543S is an 8-bit CMOS analog-to-digital converter with a maximum conversion rate of 15 MSPS.

It uses a half flash structure based on chopper comparators and achieves both high speed and low power consumption with multiplex processing.

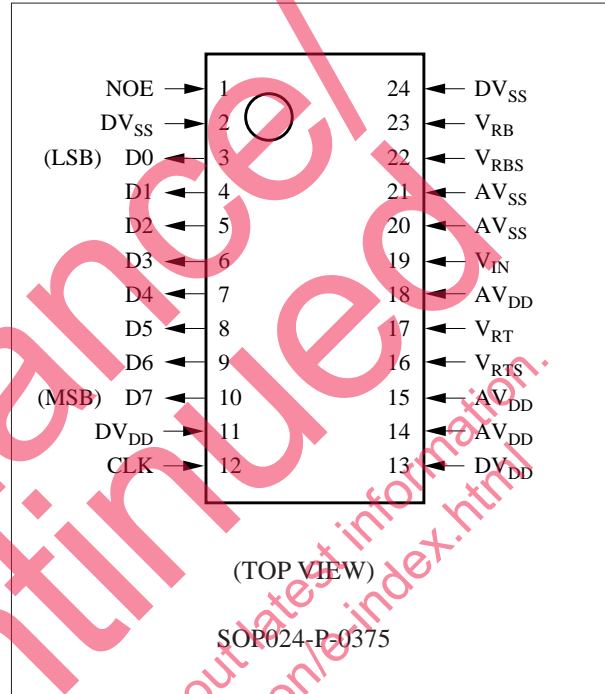
Features

- Maximum conversion rate: 15 MSPS (min.)
- Linearity error: ± 0.5 LSB (typ.)
- Differential linearity error: ± 0.3 LSB (typ.)
- Power supply voltage: 4.40 to 5.25 V
- Power consumption: 90 mW (typ.)

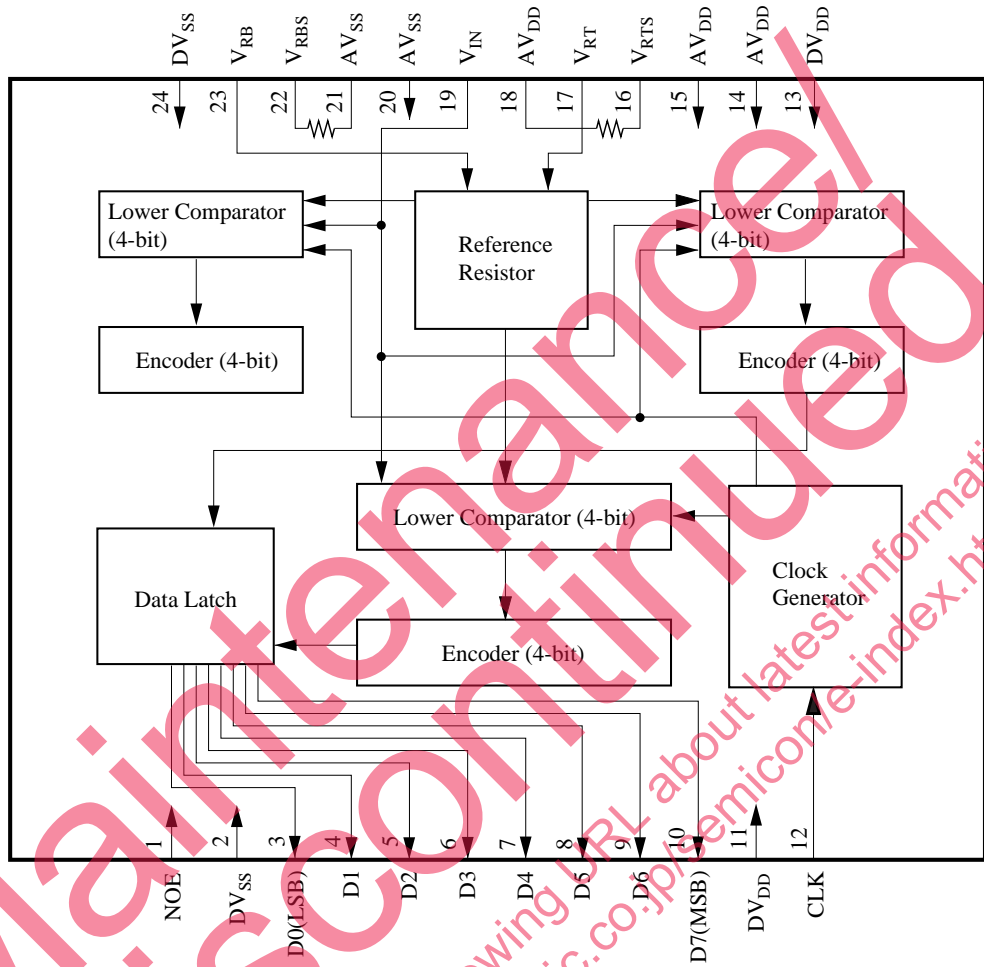
Applications

- Digital television receivers
- Digital video equipment
- Digital image processing equipment

Pin Assignment



■ Block Diagram



■ Pin Descriptions

Pin No.	Symbol	Function Description
1	NOE	Output enable
2	DV _{SS}	Ground for digital circuits
3	D0	Digital output (LSB)
4	D1	Digital output
5	D2	Digital output
6	D3	Digital output
7	D4	Digital output
8	D5	Digital output
9	D6	Digital output
10	D7	Digital output (MSB)
11	DV _{DD}	Power supply for digital circuits
12	CLK	Sampling clock
13	DV _{DD}	Power supply for digital circuits
14	AV _{DD}	Power supply for analog circuits
15	AV _{DD}	Power supply for analog circuits
16	V _{RTS}	Power supply for reference voltage (TOP)
17	V _{RT}	Reference voltage (TOP)
18	AV _{DD}	Power supply for analog circuits
19	V _{IN}	Analog input
20	AV _{SS}	Ground for analog circuits
21	AV _{SS}	Ground for analog circuits
22	V _{RBS}	Power supply for reference voltage (BOTTOM)
23	V _{RB}	Reference voltage (BOTTOM)
24	DV _{SS}	Ground for digital circuits

■ Absolute Maximum Ratings T_a=25°C

Parameter	Symbol	Rating	Unit
Power supply voltage	V _{DD}	- 0.3 to +7.0	V
Input voltage	V _I	AV _{SS} - 0.3 to AV _{DD} + 0.3	V
Output voltage	V _O	DV _{SS} - 0.3 to DV _{DD} + 0.3	V
Operating ambient temperature	T _{opr}	-20 to +70	°C
Storage temperature	T _{stg}	-55 to +125	°C

Recommended Operating Conditions $V_{DD}=AV_{DD}=DV_{DD}=5.0V, V_{SS}=AV_{SS}=DV_{SS}=0V, T_a=25^\circ C$

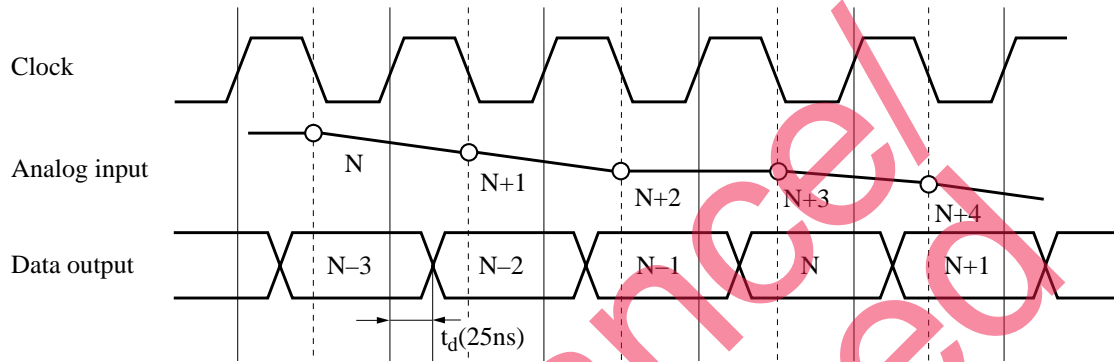
Parameter		Symbol	min	typ	max	Unit
Power supply voltage		V_{DD}	4.50	5.00	5.25	V
Digital input voltage	"H" level	V_{IH}	2.4		V_{DD}	V
	"L" level	V_{IL}	V_{SS}		0.8	V
Reference voltage	"H" level	V_{RT}	3.5		V_{DD}	V
	"L" level	V_{RB}	V_{SS}		1.5	V
Clock	"H" level pulse width	t_{WH}		30		ns
	"L" level pulse width	t_{WL}		30		ns
Analog input voltage		V_{AIN}	V_{SS}		V_{DD}	V

Electrical Characteristics $V_{DD}=AV_{DD}=DV_{DD}=5.0V, AV_{SS}=DV_{SS}=0V, T_a=25^\circ C$

Parameter		Symbol	Conditions	min	typ	max	Unit
Power supply current		I_{DD}	$f_{CLK} = 15 \text{ MHz}$ (includes reference power supply)		18	26	mA
Resolution		RES			8		bit
Linearity error		E_L	$f_{CLK}=15\text{MHz}$		± 0.5	± 1.3	LSB
Differential linearity error		E_D	$V_{RT}=3.5V, V_{RB}=1.5V$		± 0.4	± 0.8	LSB
Maximum conversion rate		$F_{c(max.)}$		15			MSPS
Clock frequency		f_{CLK}		1		15	MHz
Analog input dynamic range		D_R		2		$V_{RT}-V_{RB}$	V
Output current	"H" level	I_{OH}	$V_{OH}=V_{DD}-0.8V$			-2	mA
	"L" level	I_{OL}	$V_{OL}=0.4V$	2			mA
Output delay time		t_d	$C_L=50\text{pF}$		25	40	ns
Analog input capacitance		C_I			18		pF

■ Timing Chart

The chip samples the analog input at the falling edge of the clock signal and provides the corresponding digital output 2.5 clock cycles later at the rising edge of the clock signal.



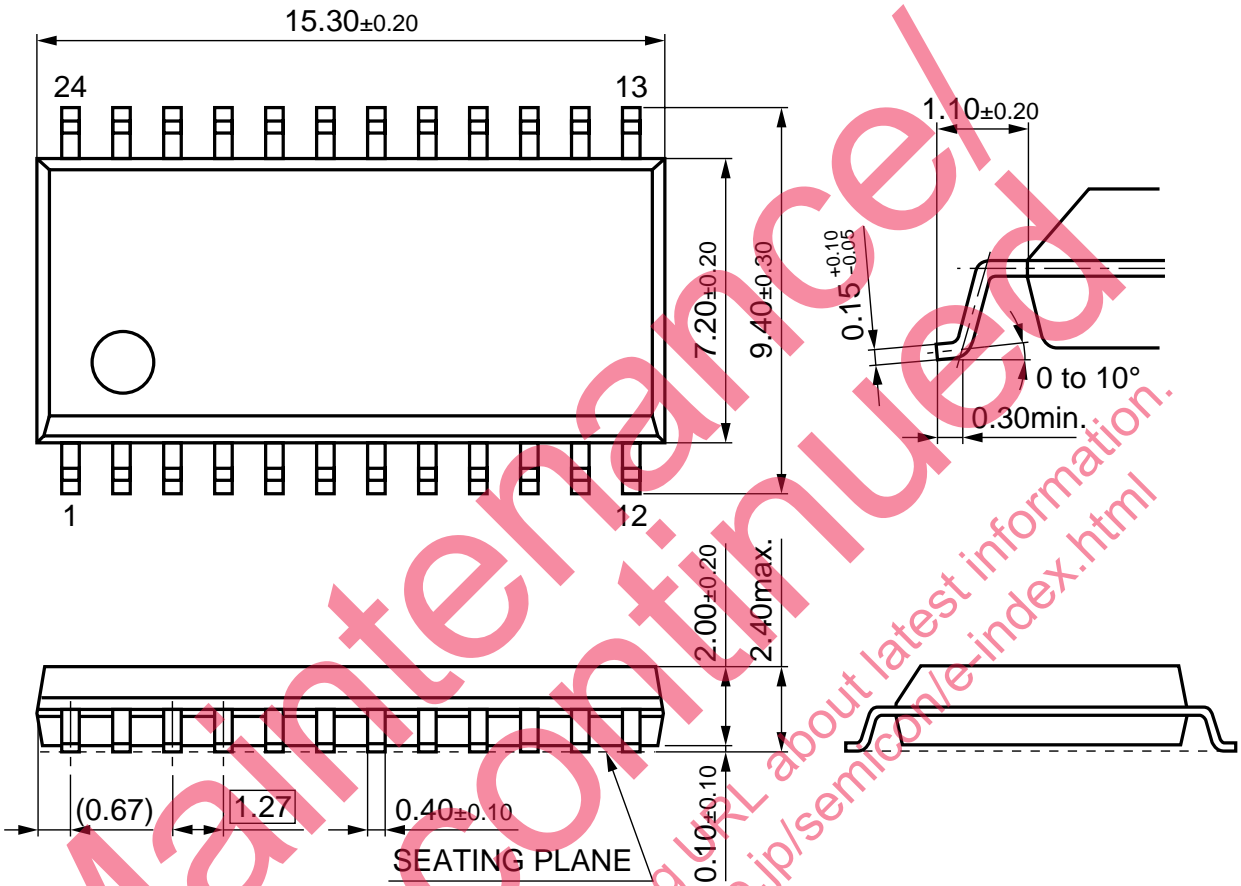
Note: The circles indicate analog signal sampling points.

Maintenance
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■ Package Dimensions (Unit:mm)

SOP024-P-0375



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